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FDD3690

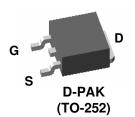
100V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

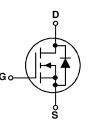
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS}(\text{ON})}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.



Features

- 22 A, 100 V. $R_{DS(ON)} = 64 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 71 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (28nC typical)
- Fast Switching
- High performance trench technology for extremely low R_{DS(ON)}
- High power and current handling capability



Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

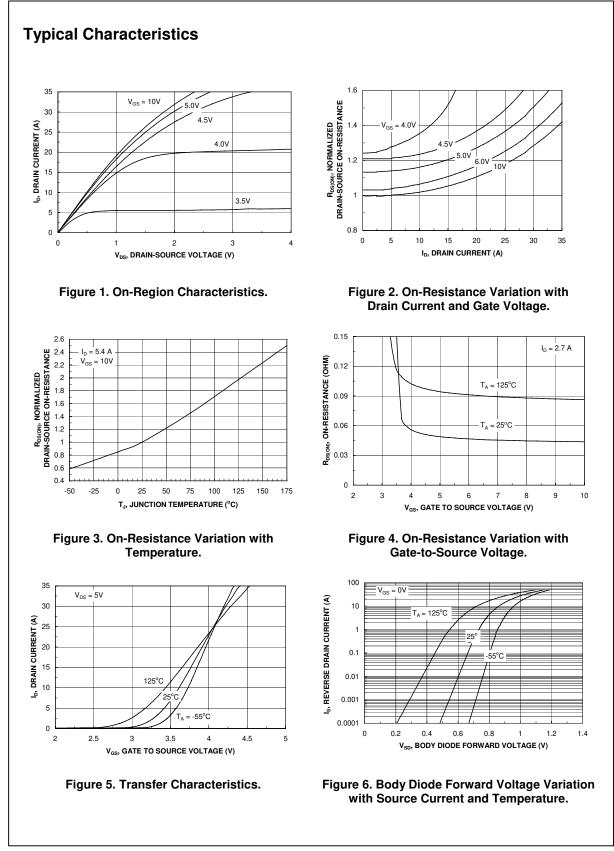
Symbol	Parameter			Ratings	Units		
V _{DSS}	Drain-Source Voltage			100			
V _{GSS}	Gate-Source Voltage	9		±20	V		
I _D	Continuous Drain Current @T _C =25°C (Note 3)			22	22 A		
		Pulsed	(Note 1a)	75			
P _D	Power Dissipation	@T _c =25°C	(Note 3)	60	W		
		@T _A =25°C	(Note 1a)	3.8			
		@T _A =25°C	(Note 1b)	1.6			
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175 °(
Therma	l Characteristi	cs					
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		(Note 1)	2.5	°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		(Note 1a)	40	°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		(Note 1b)	96	°C/W		
Packag	e Marking and	Ordering Info	rmation				
Device N			I Size	Tape width	Quantity		
	3690 FD	D3690 1					

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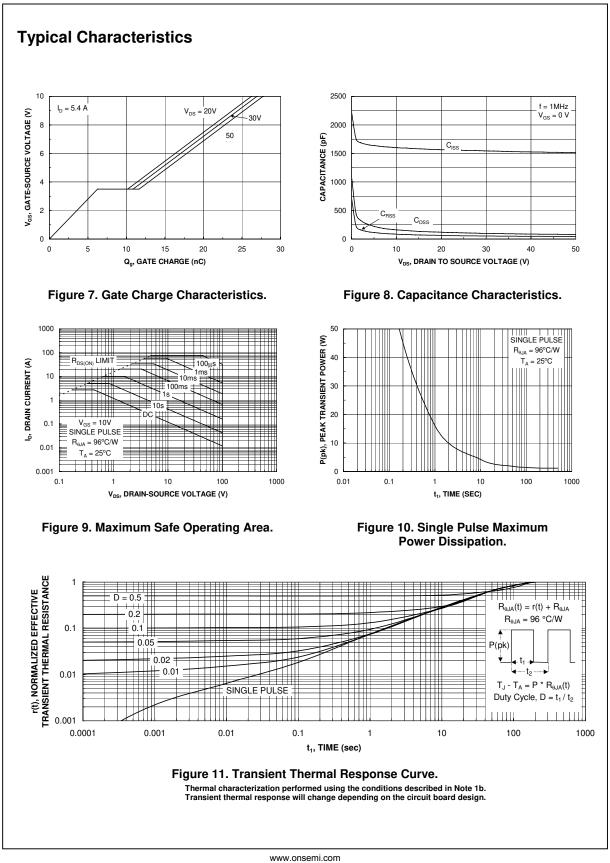
Publication Order Number: FDD3690/D

Symbol	Parameter	Test C	Conditions	Min	Тур	Max	Units
-	ource Avalanche Ratings (Note	e 2)					
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 50 \text{ V},$	I _D = 5.4 A			175	mJ
I _{AR}	Maximum Drain-Source Avalanche Current					5.4	Α
Off Char	acteristics			•	•		
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$,	I _D = 250 μA	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_{D} = 250 \ \mu A, R_{0}$	eferenced to 25°C		78		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V$,	$V_{GS} = 0 V$			10	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 V$,	$V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$	$V_{\text{DS}} = 0 V$			-100	nA
On Char	acteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D =$	250 μΑ	2	2.4	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C			-6.2		mV/°C
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{GS} = 10 V,$ $V_{GS} = 6 V,$ $V_{GS} = 10 V, I_D$	I _D = 5.4 A I _D = 5.2 A = 5.4 A, T _J = 125°C		44 47 88	64 71 135	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 V$,		20			А
g fs	Forward Transconductance	$V_{\text{DS}} = 5 V$,	I _D = 5.4 A		20		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	$V_{\text{DS}} = 50 \text{ V},$	$V_{GS} = 0 V,$		1514		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			82		pF
C _{rss}	Reverse Transfer Capacitance				44		pF
Switchin	g Characteristics (Note 2)						
t _{d(on)}	Turn-On Delay Time	$V_{\text{DD}} = 50 \text{ V},$	$I_D = 1 A$,		11	20	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 V$,	$R_{GEN} = 6 \ \Omega$		6.5	15	ns
t _{d(off)}	Turn-Off Delay Time				29	60	ns
t _f	Turn-Off Fall Time				10	20	ns
Qg	Total Gate Charge	$V_{\text{DS}} = 50 \text{ V},$	$I_{D} = 5.4 \text{ A},$		28	39	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$			6.2		nC
Q _{gd}	Gate-Drain Charge				5.4		nC
Drain-So	ource Diode Characteristics	and Maxim	um Ratings				
Is	Maximum Continuous Drain-Sourc		-			3.2	А
V _{SD}	Drain-Source Diode Forward Voltag	ge $V_{GS} = 0 V$,	I _S = 3.2 A (Note 2)		0.73	1.2	V
	a) $R_{\theta JA} = 40^{\circ}C/A$ a) $R_{\theta JA} = 40^{\circ}C/A$	rmined by the user's t N when mounted on a	ooard design.	b) R _{eJA}		when mou	
		Scale 1 : 1 on le	tter size paper				
Pulse Test: Pul	lse Width < 300 μ s, Duty Cycle < 2.0%						
Maximum ourr	ent is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$						

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4

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